

LIGHT EMITTING DIODE SPECIFICATION

DESCRIPTION:	E6C0606RGBC3UDA
REVISION:	V2.2
ISSUE DATE:	2018-07-25

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Features:

- Long operating life
- Low Power Consumption
- Wide Viewing Angle
- Low voltage DC operated
- RoHS Compliant

Application:

- Backlight
- Decoration lighting
- motormeter
- Indicator



Part Number	Dice Material	Emitted Color	Lens Color
E6C0606RGBC3UDA	AlGaInP-InGaN-InGaN	Red-Green-Blue	Water Clear or Diffused

Electro-Optical Characteristics (Ta=25°C, @5mA)

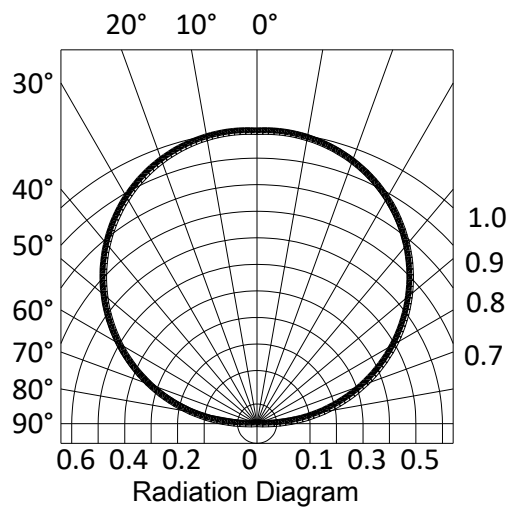
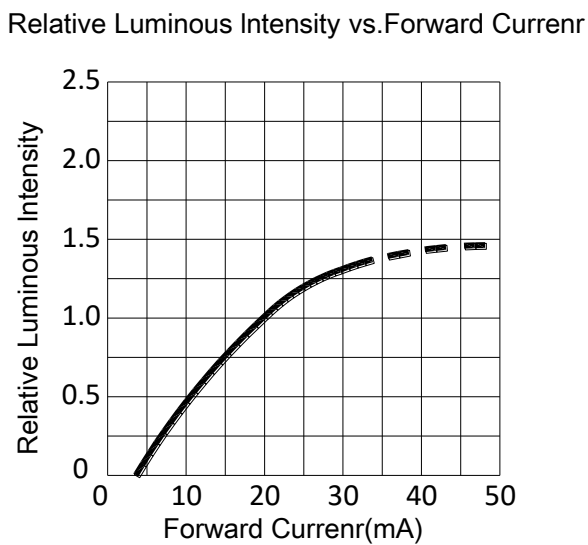
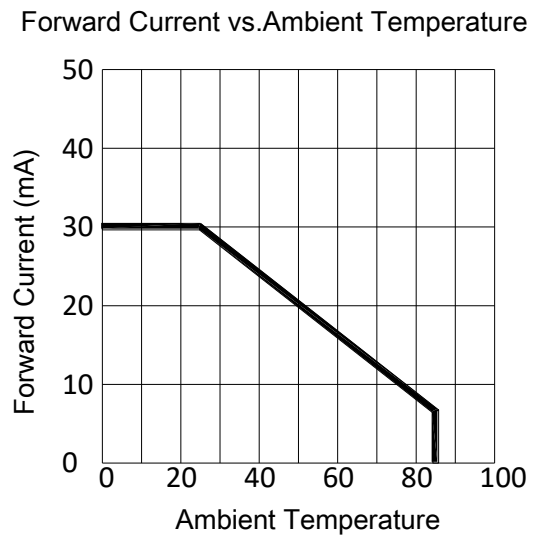
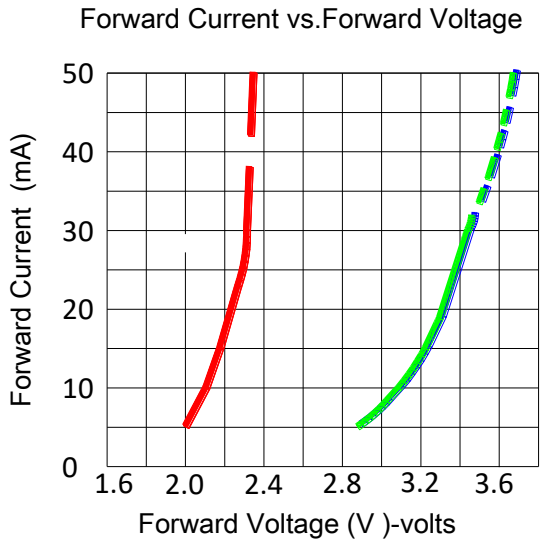
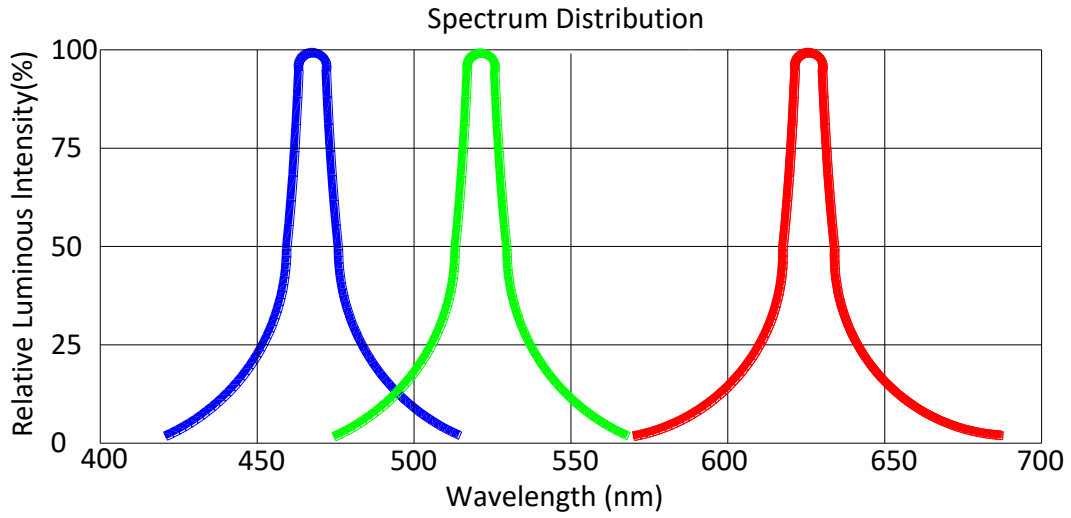
Parameter	Color	Symbol	Min.	Typ.	Max.	Unit
Luminous Intensity	■	IV	40	-	80	mcd
	■		150	-	350	
	■		30	-	70	
Radiation Bandwidth	■	Δλ	-	20	-	nm
	■		-	35	-	
	■		-	25	-	
Forward Voltage	■	VF	1.60	-	2.20	v
	■		2.50	-	3.10	
	■		2.50	-	3.10	
Dominant Wavelength	■	λd	618	620	626	nm
	■		518	520	530	
	■		460	465	472	
Viewing Angle	-	2θ1/2	-	120	-	deg
Reverse Current	-	IR	-	-	10	uA

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Max.	Unit
Peak Forward Current(1/10 Duty Cycle, 0.1ms Pulse Width)	IPF	100	mA
Forward Current	IF	20	mA
Reverse Voltage	VR	5	v
Operating Temperature Range	Topr	-40to+90	°C
Storage Temperature Range	Tstg	-40to+90	°C
Reflow Soldering	Tsld	260°C for 10secs	



Optical & Electrical Characteristics





Bin Limits@Red

Bin Range Of Luminous Intensity (Unit:mcd)

Bin Code	Min	Max	Condition
L1	40	60	IF=5mA
L2	60	80	
L3	-	-	

Bin Range Of Forward Voltage (Unit:V)

Bin Code	Min	Max	Condition
V1	1.6	1.8	IF=5mA
V2	1.8	2.0	
V3	2.0	2.2	
V4	-	-	
V5	-	-	

Bin Range Of Wavelength (Unit:nm)

Bin Code	Min	Max	Condition
R1	618	622	IF=5mA
R2	622	626	
R3	-	-	
R4	-	-	
R5	-	-	

Notes:

- 1.Tolerance of Luminous Intensity $\pm 10\%$
- 2.Tolerance of Forward Voltage $\pm 0.1V$



Bin Limits@Green

Bin Range Of Luminous Intensity (Unit:mcd)

Bin Code	Min	Max	Condition
L1	150	250	IF=5mA
L2	250	350	
L3	-	-	

Bin Range Of Forward Voltage (Unit:V)

Bin Code	Min	Max	Condition
V1	2.5	2.7	IF=5mA
V2	2.7	2.9	
V3	2.9	3.1	
V4	-	-	
V5	-	-	

Bin Range Of Wavelength (Unit:nm)

Bin Code	Min	Max	Condition
G1	518	522	IF=5mA
G2	512	526	
G3	526	530	
G4	-	-	
G5	-	-	
G6	-	-	

Notes:

- 1.Tolerance of Luminous Intensity $\pm 10\%$
- 2.Tolerance of Forward Voltage $\pm 0.1V$



Bin Limits@Blue

Bin Range Of Luminous Intensity (Unit:mcd)

Bin Code	Min	Max	Condition
L1	40	60	IF=5mA
L2	60	80	
L3	-	-	

Bin Range Of Forward Voltage (Unit:V)

Bin Code	Min	Max	Condition
V1	2.5	2.7	IF=5mA
V2	2.7	2.9	
V3	2.9	3.1	
V4	-	-	
V5	-	-	

Bin Range Of Wavelength (Unit:nm)

Bin Code	Min	Max	Condition
B1	460	464	IF=5mA
B2	464	468	
B3	468	472	
B4	-	-	
B5	-	-	
B6	-	-	

Notes:

- 1.Tolerance of Luminous Intensity $\pm 10\%$
- 2.Tolerance of Forward Voltage $\pm 0.1V$

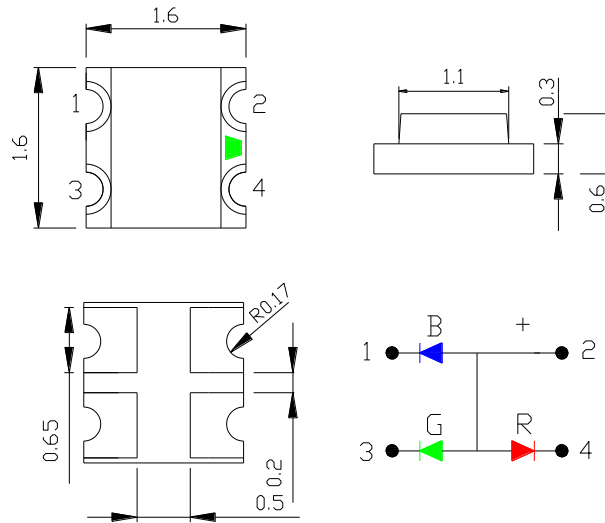
**Reliability Test Items And Conditions**

Test Items	Reference	Test Conditions	Time	Quantity	Criterion
Thermal Shock	MIL-STD-202G	-40°C (30min) -100°C (30min)	100 Cycles	22	0/22
Temperature And Humidity Cyclic	JEITA ED-4701 200 203	-10°C~65°C ; 0%~90%RH	10cycles	22	0/22
High Temperature Storage	JEITA ED -4071 200 201	Ta=100°C	1000H	22	0/22
Low Temperature Storage	JEITA ED -4071 200 202	Ta=-40°C	1000H	22	0/22
High Temperature High Humidity Storage	JEITA ED -4071 100 103	Ta=60°C ; RH=90%	1000H	22	0/22
High Temperature Life Test	JESD22-A108D	Ta=80°C	1000H	22	0/22
Life Test	JESD22-A108D	Ta=25°C IF=20mA	1000H	22	0/22
Resistance to Soldering Heat	GB/T 4937, II , 2.2&2.3	Tsol*=(240±5) °C 10secs	2 times	22	0/22

Criteria For Judging Damage

Test Items	Symbol	Test Conditions	Criteria For Judging Damage
Forward Voltage	V _F	I _F =I _{FT}	Initial Data±10%
Reverse Current	I _R	V _R =5V	I _R ≤10uA
Luminous Intensity	I _V	I _F =I _{FT}	Average I _V degradation≤30% ; Single LED I _V degradation≤50%
Resistance to Soldering Heat	-	-	Material without internal cracks,no material between stripped,no dead light

Product size (Unit:mm)

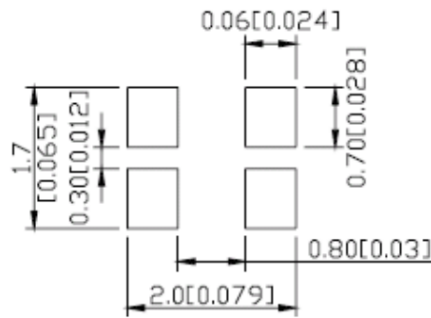


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NOTES :

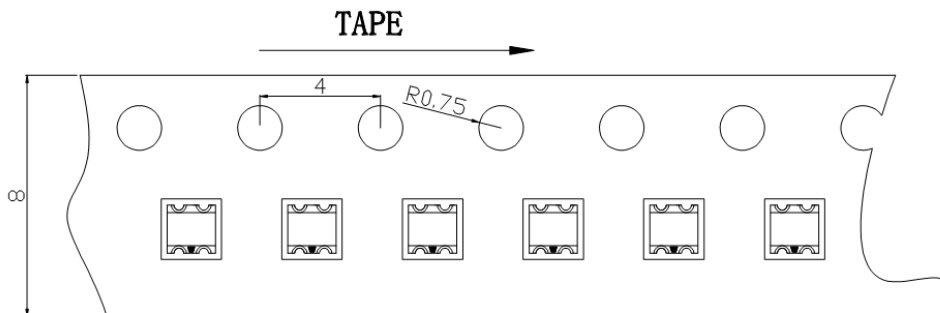
1. All dimensions are in millimeters (inches)
2. Tolerances are $\pm 0.2\text{mm}$ (0.008inch) unless otherwise noted

Recommended Soldering Pad Design (Unit:mm)

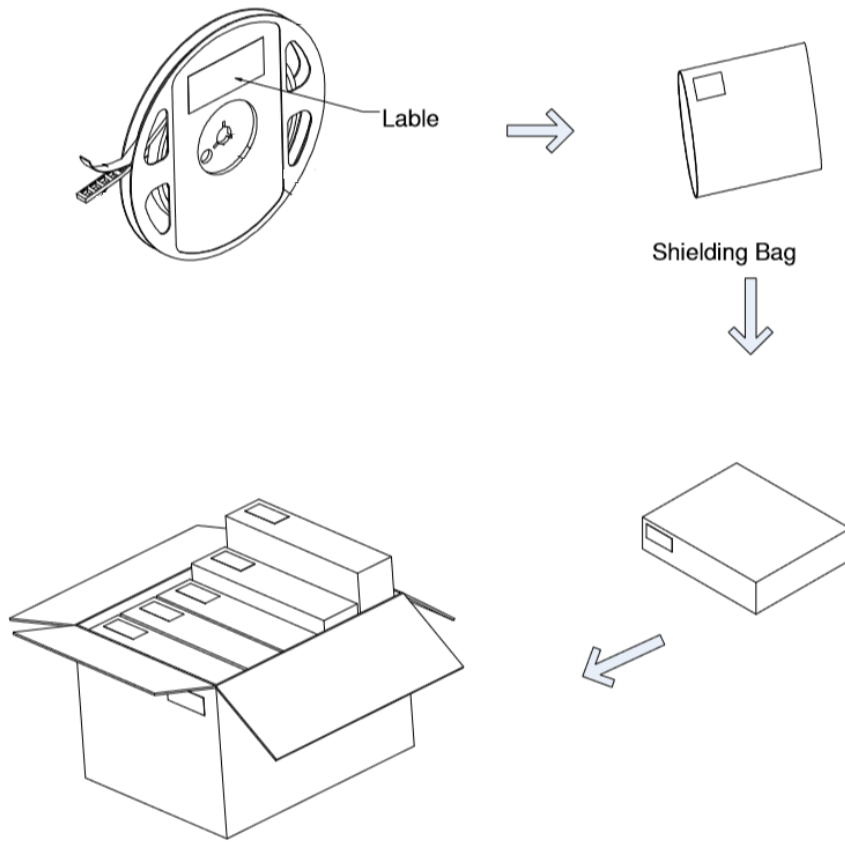


Taping and package Spec

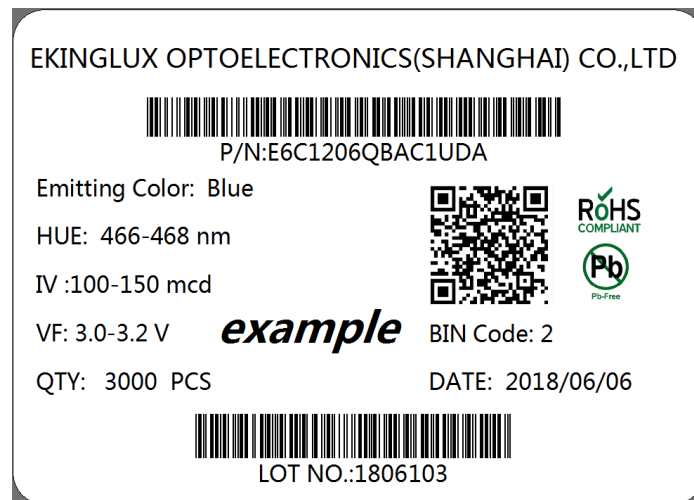
- Tape Specification:3,000pcs Per Reel



Packaging



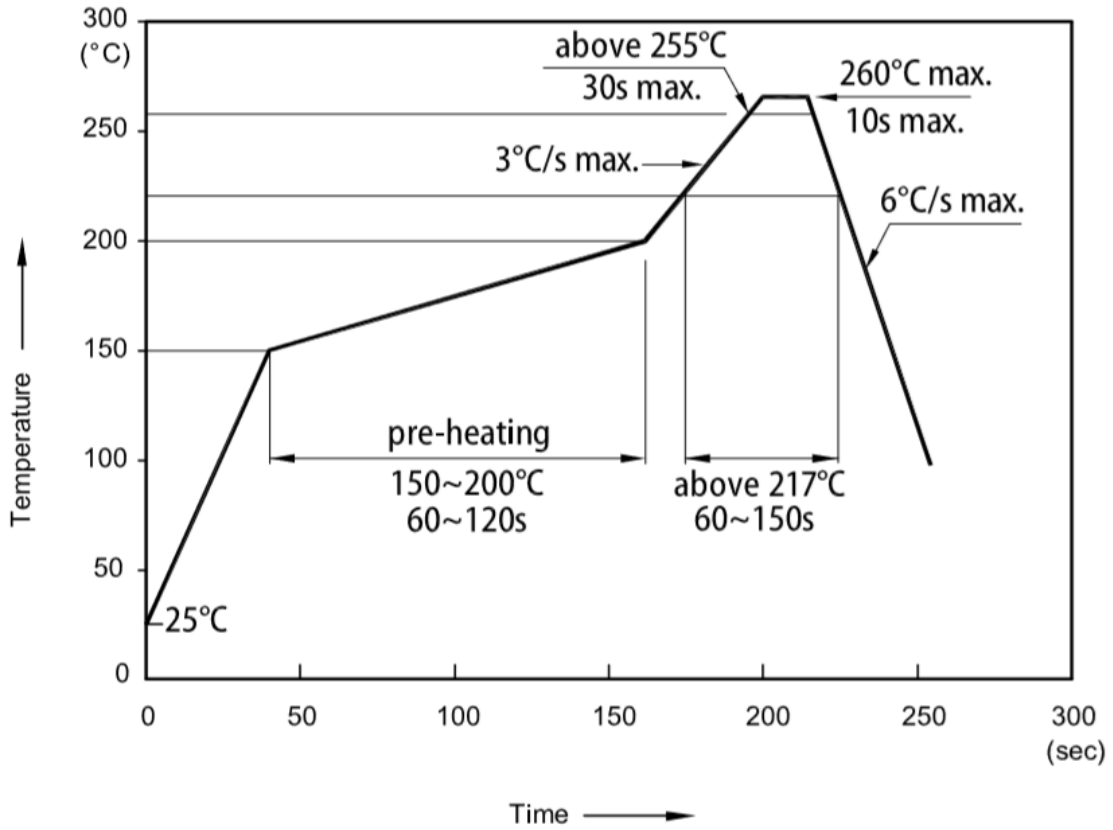
LabelStyle





Useful hint

Reflow Soldering Instructions



1. Don't cause stress to the LEDs while it is exposed to high temperature.
2. The maximum number of reflow soldering passes is 2 times.
3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

Precautions

1. Storage:

- Moisture proof and anti-electrostatic package with moisture absorbent material is used, to keep moisture to a minimum.
- Before opening the package, the product should be kept at 30°C or less and humidity less than 60% RH, and be used within a year.
- After opening the package, the product should be stored at 30°C or less and humidity less than 10%RH, and be soldered within 24 hours (1day). It is recommended that the product be operated at the workshop condition of 30°C or less and humidity less than 60%RH.
- If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed based on the following condition: (70±5)°C for 24 hours.

2. Static Electricity:

Static electricity or surge voltage damages the LEDs. Damaged LEDs will show some unusual characteristics such as the forward voltage becoming lower, or the LEDs do not light at the low current, even not light.

All devices, equipment and machinery must be properly grounded. At the same time, it is recommended that wrist bands or anti-electrostatic gloves, anti-electrostatic containers be used when dealing with the LEDs.

3. Vulcanization:

LED curing is due to sulfur being in brackets and the +1 price of silver in the chemical reaction generated Ag₂S in the process. It will lead to the capacity of reflecting of silver layer reducing, light color temperature drift and serious decline, seriously affecting the performance of the product. So we should take corresponding measures to avoid vulcanization, such as to avoid using sulphur volatile substances and keeping away from high sulphur content of the material.